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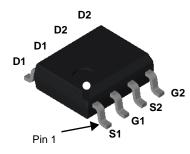
ON Semiconductor®

FDS8935 Dual P-Channel PowerTrench[®] MOSFET

-80 V, -2.1 A, 183 m Ω

Features

- Max $r_{DS(on)}$ = 183 m Ω at V_{GS} = -10 V, I_D = -2.1 A
- Max r_{DS(on)} = 247 mΩ at V_{GS} = -4.5 V, I_D = -1.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- RoHS Compliant

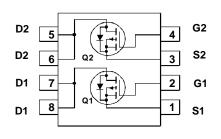


General Description

This P-channel MOSFET is produced using ON Semiconductor's advanced PowerTrench® process that has been optimized for r_{DS(on)}, switching performance and ruggedness.

Applications

- Load Switch
- Synchronous Rectifier



SO-8

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			-80	V	
V _{GS}	Gate to Source Voltage			±20	V	
I _D	Drain Current -Continuous -2.1				•	
	-Pulsed			-10	— A	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	37	mJ	
P _D	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1	W	
	Power Dissipation	T _A = 25 °C	(Note 1b)	1.6	vv	
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	(Note 1)	40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	78	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8935	FDS8935	SO-8	13 "	12 mm	2500 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_{D} = -250 \ \mu A, \ V_{GS} = 0 \ V$	-80			V	
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, referenced to 25 °C		-61		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -64 V, V _{GS} = 0 V			-1	μΑ	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	octeristics			•	•	•	
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \ \mu A$	-1	-1.8	-3	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250 µA, referenced to 25 °C		5		mV/°C	
r _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = -10 V, I _D = -2.1 A		148	183	mΩ	
		V _{GS} = -4.5 V, I _D = -1.9 A		176	247		
		V _{GS} = -10 V, I _D = -2.1 A,T _J = 125 °C		249	308		
9 _{FS}	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.1 \text{ A}$		6.4		S	
•	Characteristics						
C _{iss}	Input Capacitance	V _{DS} = -40 V, V _{GS} = 0 V,		661	879	pF	
C _{oss}	Output Capacitance	$v_{DS} = -40 v, v_{GS} = 0 v,$ 		47	63	pF	
C _{rss}	Reverse Transfer Capacitance			24	36	pF	
R _g	Gate Resistance			6		Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			5	10	ns	
t _r	Rise Time	V _{DD} = -40 V, I _D = -2.1 A,		3	10	ns	
d(off)	Turn-Off Delay Time	V_{GS} = -10 V, R_{GEN} = 6 Ω		22	36	ns	
t _f	Fall Time			3	10	ns	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } -10 V$		13	19	nC	
Q _{g(TOT)}	Total Gate Charge	$V_{GS} = 0 V \text{ to } -5 V V_{DD} = -40 V,$		7	10	nC	
Q _{gs}	Gate to Source Charge	I _D = -2.1 A		1.6		nC	
Q _{gd}	Gate to Drain "Miller" Charge			2.6		nC	
Drain-Sou	urce Diode Characteristics						
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-1.8	-1.3	- V	
		$V_{GS} = 0 V, I_S = -1.3 A$ (Note 2)		-0.8	-1.2		
t _{rr}	Reverse Recovery Time			19	30	ns	
~		– I _F = -2.1 A, di/dt = 300 A/μs				1	

Q_{rr} NOTES:

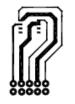
1. R_{01A} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%. 3. Starting T_J = 25 °C, L = 3.0 mH, I_{AS} = -5.0 A, V_DD = -80V, V_GS = -10V.

Reverse Recovery Charge





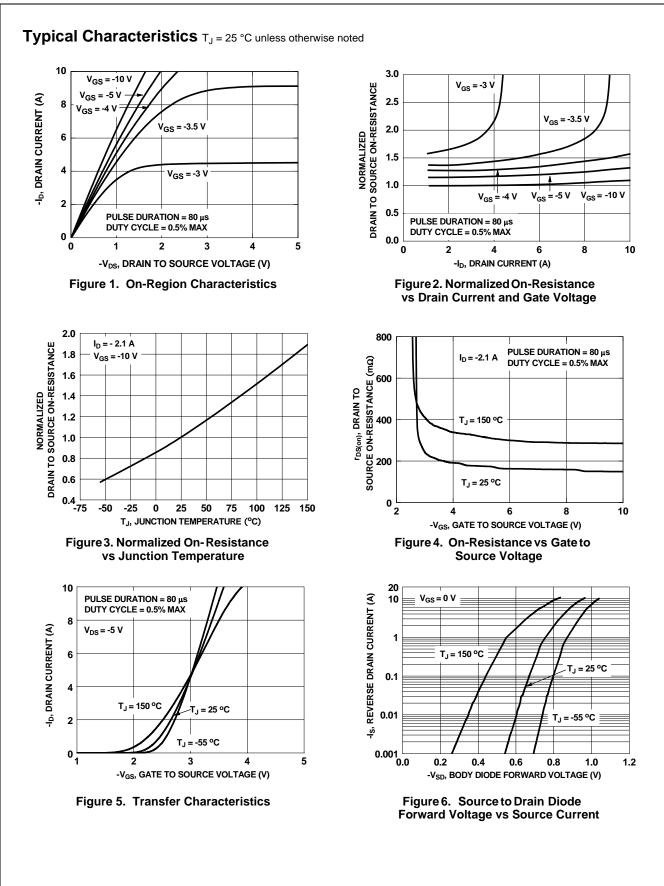
b)135 °C/W when mounted on a minimun pad

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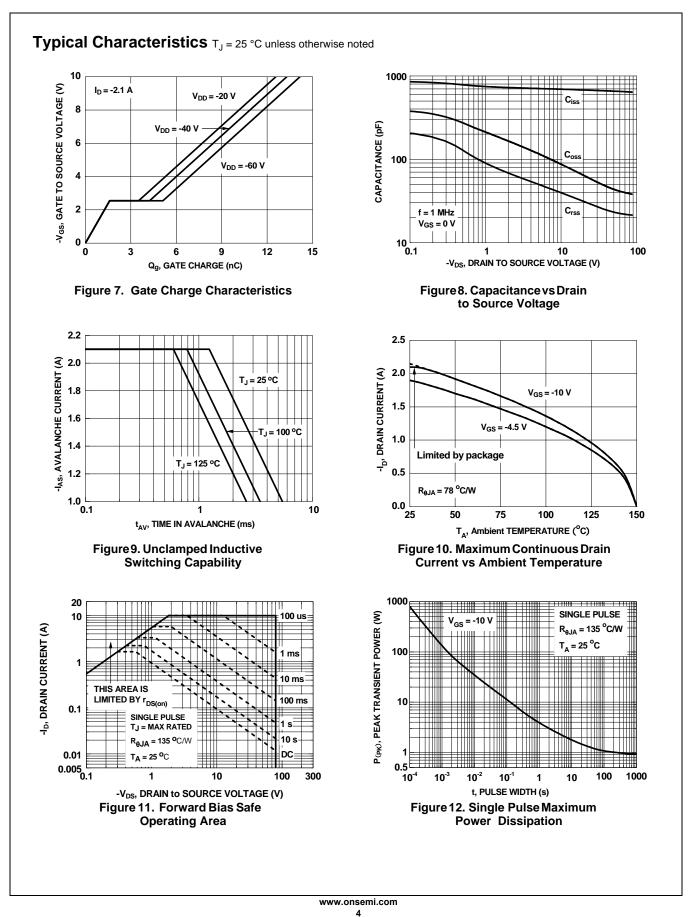
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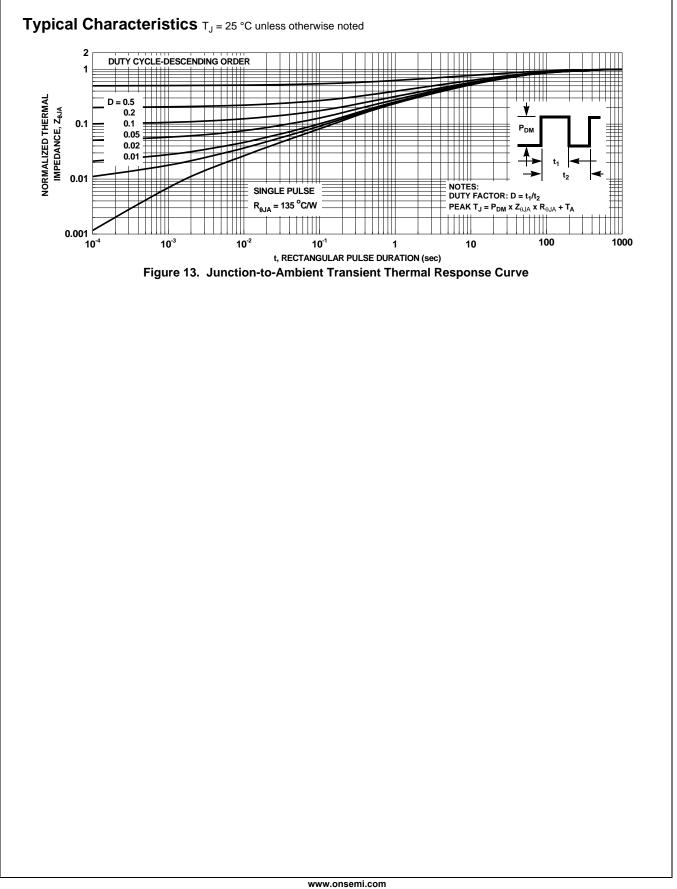
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